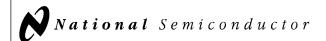
# **DS8654**

DS8654 8-Output Display Driver (LED, VF, Thermal Printer)



Literature Number: SNOSBM7A



# DS8654 8-Output Display Driver (LED, VF, Thermal Printer)

### **General Description**

DS8654 is an 8-digit driver with emitter/follower outputs. It can source up to 50 mA at a low impedance, and operates with a constant internal drive current over a wide range of power supply—from 4.5V to 33V. The DS8654 can be used to drive electrical or mechanical, multiplexed or unmultiplexed display systems. It can be used as a segment driver for common cathode displays with external current limiting resistors or can drive incandescent or fluorescent displays directly, both digits (anodes) and segments (grids). It will be necessary to run the device at a lower duty cycle, to keep the maximum package do power dissipation less than 600 mW while operating all 8 outputs at high supply voltage

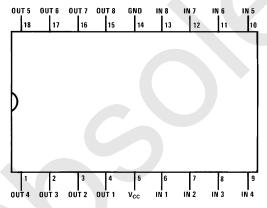
and large source current. The inputs are MOS compatible and eliminate the need for level shifting since inputs are referenced to the most negative supply of system.

#### **System Description**

The DS8654 is specifically designed to operate a thermal printing head for calculator or other uses. In this application the same segment in each digit is selected at the same time, reducing the overall time for a complete print cycle. The DS8654 is an 8-digit driver. With a 15-digit print head, two of the DS8654 are required.

#### **Connection Diagram**

#### **Dual-In-Line Package**



TL/F/5833-1

Top View
Order Number DS8654N
See NS Package Number N18A

#### **Absolute Maximum Ratings** (Note 1)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/Distributors for availability and specifications.

Supply Voltage 36V Input Voltage 36V Output Voltage  $V_{CC} - 36V$  Storage Temperature Range  $-65^{\circ}\text{C} \text{ to } + 150^{\circ}\text{C}$ 

Maximum Power Dissipation\* at 25°C

Molded Package 1563 mW Lead Temperature (Soldering, 4 seconds) 260°C

\*Derate molded package 12.5 mW/°C above 25°C.

## **Operating Conditions**

	Min	Max	Units
Supply Voltage (V <sub>CC</sub> )	4.5	33	V
Temperature (T <sub>A</sub> )	0	+70	°C

TL/F/5833-2

### Electrical Characteristics (Notes 2 and 3)

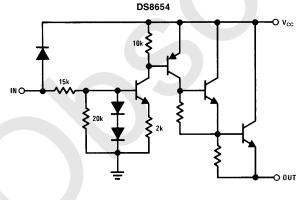
Symbol	Parameter	Conditions	Min	Тур	Max	Units
I <sub>IH</sub>	Logical "1" Input Current	$V_{CC} = Max, V_{IN} = 6.5V$		390	500	μΑ
I <sub>IL</sub>	Logical "0" Input Current	$V_{CC} = Max, V_{IN} = 0.4V$		13	40	μΑ
l <sub>OFF</sub>	"Off" State Leakage Current	$V_{OUT} = V_{CC} - 33V$		0.01	-100	μΑ
V <sub>ON</sub>	"On" State Output Voltage	$V_{CC} = Max$ , $I_{IN} = 500 \mu A$ , $I_{OH} = -50 mA$		V <sub>CC</sub> - 1.8	V <sub>CC</sub> - 2.5	٧
I <sub>CC(OFF)</sub>	Supply Current	$V_{CC} = Max, V_{IN} = V_{OUT} = GND$		0.01	1.0	mA
I <sub>CC(ON)</sub>	Supply Current (All Outputs "ON")	$V_{CC} = Max, V_{IN} = 6.5V,$ $I_{OUT} = 0 \text{ mA}$		7.5	10	mA

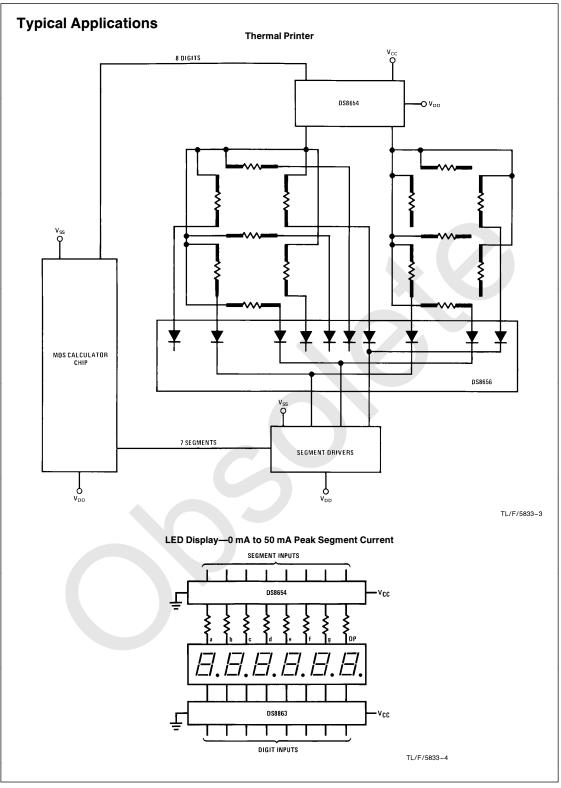
Note 1: "Absolute Maximum Ratings" are those values beyond which the safety of the device cannot be guaranteed. They are not meant to imply that the devices should be operated at these limits. The table of "Electrical Characteristics" provides conditions for actual device operation.

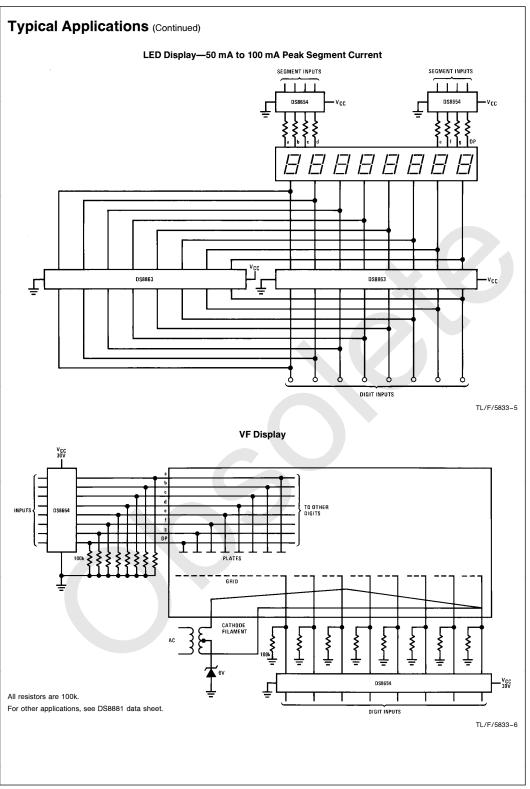
Note 2: Unless otherwise specified min/max limits apply across the  $0^{\circ}$ C to  $+70^{\circ}$ C range for the DS8654. All typicals are given for  $V_{CC}=30V$  and  $T_{A}=25^{\circ}$ C.

Note 3: All currents into device pins shown as positive, out of device pins as negative, all voltages referenced to ground unless otherwise noted. All values shown as max or min on absolute value basis.

## **Schematic Diagram**

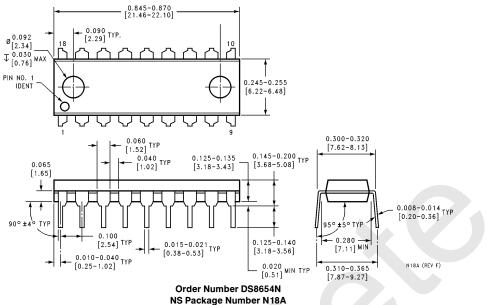








# Physical Dimensions inches (millimeters)



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